

200623797 Additional Assembly, Test & Ship Site for xGM210P Modules

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Effective Date: 6/23/2020

Description of Change

Silicon Labs is pleased to announce the successful qualification of Ryder Shenzhen as an additional assembly, test and ship site for xGM210P modules. Ryder is an existing supplier for Silicon Labs, certified and registered to ISO9001, ISO14001 and IATF 16949.

The address for Ryder Shenzhen is:

Ryder Electronics (Shenzhen) Ltd. 139 Da Bao Raod, District 33, Bao An, Shenzhen, China 518133

After the effective date, Silicon Labs may assemble, test and ship from either of the qualified Assembly, Test and Ship sites.

Reason for Change

Alternate sites for capacity expansion

Product Identification

Existing Part # BGM210PA22JIA2 BGM210PA22JIA2R BGM210PA32JIA2 BGM210PA32JIA2R MGM210PA22JIA2R MGM210PA32JIA2R MGM210PA32JIA2R

This change is considered a minor change which does not affect form, fit, function, quality, or reliability. The information is being provided as a customer courtesy.

Please contact your local Silicon Labs sales representative with any questions about this notification. A list of Silicon Labs sales representatives may be found at <u>http://www.silabs.com</u>.

Customer Actions Needed:

None.

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